

# **BGA2717**

## **MMIC** wideband amplifier

Rev. 02 — 24 September 2004

**Product data sheet** 



### 1.1 General description

Silicon Monolithic Microwave Integrated Circuit (MMIC) wideband amplifier with internal matching circuit in a 6-pin SOT363 SMD plastic package.

#### **CAUTION**



This device is sensitive to electrostatic discharge (ESD). Therefore care should be taken during transport and handling.

#### 1.2 Features

- Internally matched to 50  $\Omega$
- Wide frequency range (3.2 GHz at 3 dB bandwidth)
- Flat 24 dB gain (±1 dB up to 2.8 GHz)
- -2.5 dBm output power at 1 dB compression point
- Good linearity for low current (IP3<sub>out</sub> = 10 dBm)
- Low second harmonic; –38 dBc at P<sub>D</sub> = –40 dBm
- Low noise figure; 2.3 dB at 1 GHz
- Unconditionally stable  $(K \ge 2)$ .

### 1.3 Applications

- LNB IF amplifiers
- Cable systems
- ISM
- General purpose.

#### 1.4 Quick reference data

Table 1: Quick reference data

| Symbol                         | Parameter            | Conditions | Min | Тур | Max | Unit |
|--------------------------------|----------------------|------------|-----|-----|-----|------|
| $V_S$                          | DC supply voltage    |            | -   | 5   | 6   | V    |
| Is                             | supply current       |            | -   | 8   | -   | mA   |
| s <sub>21</sub>   <sup>2</sup> | insertion power gain | f = 1 GHz  | -   | 24  | -   | dB   |
| NF                             | noise figure         | f = 1 GHz  | -   | 2.3 | -   | dB   |
| P <sub>L(sat)</sub>            | saturated load power | f = 1 GHz  | -   | 1   | -   | dBm  |



## 2. Pinning information

Table 2: Pinning

|      | 3           |                           |
|------|-------------|---------------------------|
| Pin  | Description | Simplified outline Symbol |
| 1    | $V_S$       |                           |
| 2, 5 | GND2        |                           |
| 3    | RF_OUT      | 6-                        |
| 4    | GND1        |                           |
| 6    | RF_IN       | 0 4 2,5                   |
|      |             | sym052                    |
|      |             | SOT363                    |

## 3. Ordering information

**Table 3: Ordering information** 

| Type number | Package |  |         |
|-------------|---------|--|---------|
|             | Name    | Description                              | Version |
| BGA2717     | -       | plastic surface mounted package; 6 leads | SOT363  |

## 4. Marking

Table 4: Marking

| Type number | Marking code |
|-------------|--------------|
| BGA2717     | 1B-          |

## 5. Limiting values

Table 5: Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol           | Parameter               | Conditions              | Min | Max  | Unit |
|------------------|-------------------------|-------------------------|-----|------|------|
| Vs               | DC supply voltage       | RF input AC coupled     | -   | 6    | V    |
| Is               | supply current          |                         | -   | 15   | mA   |
| P <sub>tot</sub> | total power dissipation | T <sub>sp</sub> ≤ 90 °C | -   | 200  | mW   |
| T <sub>stg</sub> | storage temperature     |                         | -65 | +150 | °C   |
| Tj               | junction temperature    |                         | -   | 150  | °C   |
| P <sub>D</sub>   | maximum drive power     |                         | -   | -10  | dBm  |

## 6. Thermal characteristics

Table 6: Thermal characteristics

| Symbol                | Parameter  | Conditions   | Тур | Unit |
|-----------------------|--|--|-----|------|
| R <sub>th(j-sp)</sub> | thermal resistance from junction to solder point | $P_{tot}$ = 200 mW;<br>$T_{sp} \le 90  ^{\circ}\text{C}$ | 300 | K/W  |

## 7. Characteristics

**Table 7: Characteristics** 

 $V_S$  = 5 V;  $I_S$  = 8 mA;  $T_j$  = 25 °C; measured on demo board; unless otherwise specified.

| Symbol                         | Parameter                            | Conditions  | Min | Тур   | Max | Unit |
|--------------------------------|--------------------------------------|---|-----|-------|-----|------|
| I <sub>S</sub>                 | supply current                       |   | 6   | 8     | 10  | mA   |
| s <sub>21</sub>   <sup>2</sup> | insertion power                      | f = 100 MHz   | 18  | 18.6  | 20  | dB   |
|                                | gain                                 | f = 1 GHz   | 23  | 23.9  | 25  | dB   |
|                                |                                      | f = 1.8 GHz   | 24  | 25    | 27  | dB   |
|                                |                                      | f = 2.2 GHz   | 24  | 25.1  | 27  | dB   |
|                                |                                      | f = 2.6 GHz   | 22  | 24    | 26  | dB   |
|                                |                                      | f = 3 GHz   | 20  | 22.1  | 24  | dB   |
| s <sub>11</sub>   <sup>2</sup> | input return                         | f = 1 GHz   | 15  | 19    | -   | dB   |
|                                | losses                               | f = 2.2 GHz   | 8   | 9.4   | -   | dB   |
| s <sub>22</sub>   <sup>2</sup> | output return                        | f = 1 GHz   | 8   | 10    | -   | dB   |
|                                | losses                               | f = 2.2 GHz   | 5   | 6.8   | -   | dB   |
| s <sub>12</sub>   <sup>2</sup> | isolation                            | f = 1.6 GHz   | 54  | 55    | -   | dB   |
|                                |                                      | f = 2.2 GHz   | 38  | 39    | -   | dB   |
| NF                             | noise figure                         | f = 1 GHz   | -   | 2.3   | 2.5 | dB   |
|                                |                                      | f = 2.2 GHz   | -   | 2.9   | 3.1 | dB   |
| В                              | bandwidth                            | at  s21 2 –3 dB below flat<br>gain at 1 GHz           | 3   | 3.2   | -   | GHz  |
| K                              | stability factor                     | f = 1 GHz   | -   | 13    | -   |      |
|                                |                                      | f = 2.2 GHz   | -   | 1.7   | -   |      |
| P <sub>L(sat)</sub>            | saturated load power                 | f = 1 GHz   | 0   | 1.4   | -   | dBm  |
|                                |                                      | f = 2.2 GHz   | -1  | +0.1  | -   | dBm  |
| P <sub>L(1dB)</sub>            | load power                           | at 1 dB gain compression;<br>f = 1 GHz                | -4  | -2.6  | -   | dBm  |
|                                |                                      | at 1 dB gain compression;<br>f = 2.2 GHz              | -5  | -3.1  | -   | dBm  |
| IM2                            | second order intermodulation product | at $P_D = -40 \text{ dBm}$ ;<br>$f_0 = 1 \text{ GHz}$ | 36  | 38    | -   | dBc  |
| IP3 <sub>in</sub>              | input, third                         | f = 1 GHz   | -15 | -13.9 | -   | dBm  |
|                                | order intercept<br>point             | f = 2.2 GHz   | -20 | -18.8 | -   | dBm  |
| IP3 <sub>out</sub>             | output, third                        | f = 1 GHz   | 9   | 10    | -   | dBm  |
|                                | order intercept<br>point             | f = 2.2 GHz   | 4   | 6.3   | -   | dBm  |

## 8. Application information

<u>Figure 1</u> shows a typical application circuit for the BGA2717 MMIC. The device is internally matched to  $50~\Omega$ , and therefore does not need any external matching. The value of the input and output DC blocking capacitors C2 and C3 should not be more than 100 pF for applications above 100 MHz. However, when the device is operated below 100 MHz, the capacitor value should be increased.

The 22 nF supply decoupling capacitor C1 should be located as close as possible to the MMIC.

The printed-circuit board (PCB) top ground plane, connected to pins 2, 4 and 5 must be as close as possible to the MMIC, and ideally directly beneath it. When using via holes, use multiple via holes, located as close as possible to the MMIC.

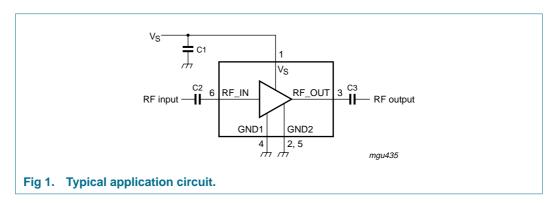
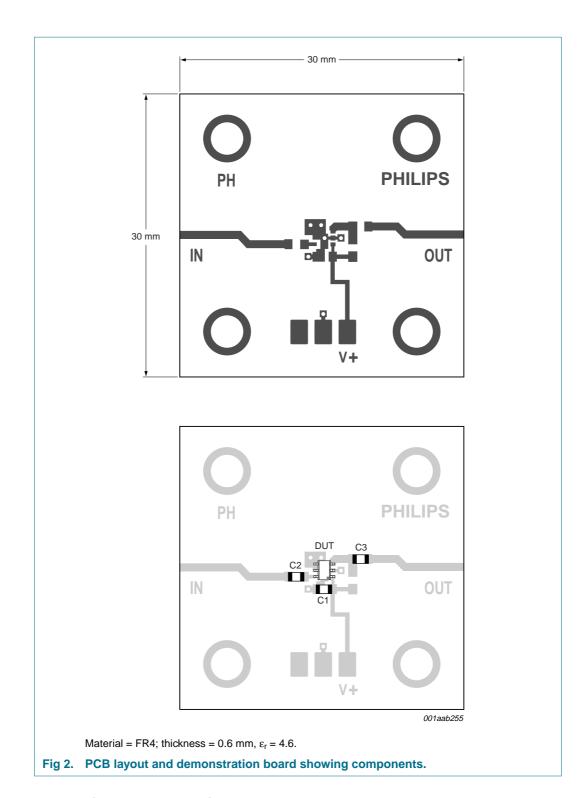


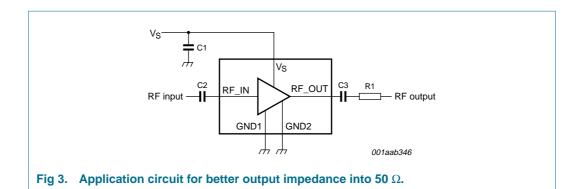
Figure 2 shows the PCB layout, used for the standard demonstration board.



## 8.1 Grounding and output impedance

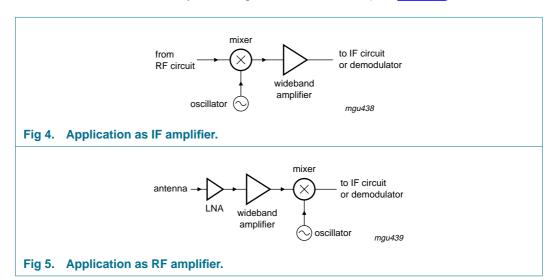
If the grounding is not optimal, the gain becomes less flat and the 50  $\Omega$  output matching becomes worse. If a better output matching to 50  $\Omega$  is required, a 12  $\Omega$  resistor (R1) can be placed in series with C3 (see <u>Figure 3</u>). This will significantly improve the output impedance, at the cost of 1 dB gain and 1 dB output power.

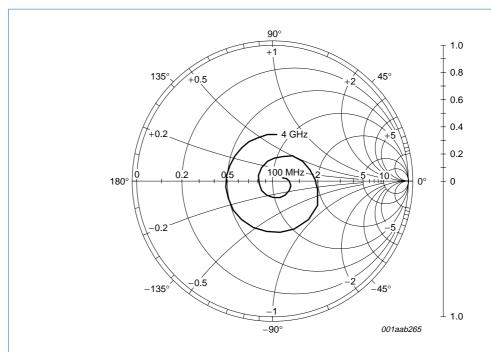
### **MMIC** wideband amplifier



## 8.2 Application examples

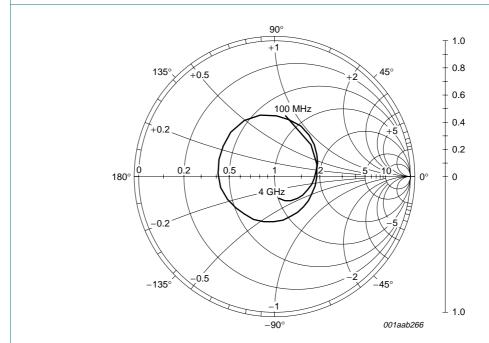
The MMIC is very suitable as IF amplifier in e.g. LNBs. The excellent wideband characteristics make it an ideal building block (see Figure 4). As second amplifier after an LNA, the MMIC offers an easy matching, low noise solution (see Figure 5).





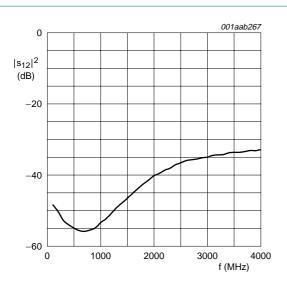
 $I_S$  = 8 mA;  $V_S$  = 5 V;  $P_D$  = –35 dBm;  $Z_o$  = 50  $\Omega.$ 

Fig 6. Input reflection coefficient  $(s_{11})$ ; typical values.



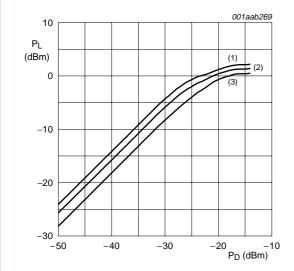
 $I_S$  = 8 mA;  $V_S$  = 5 V;  $P_D$  = –35 dBm;  $Z_o$  = 50  $\Omega.$ 

Fig 7. Output reflection coefficient (s<sub>22</sub>); typical values.



 $I_S$  = 8 mA;  $V_S$  = 5 V;  $P_D$  = –35 dBm;  $Z_o$  = 50  $\Omega.$ 

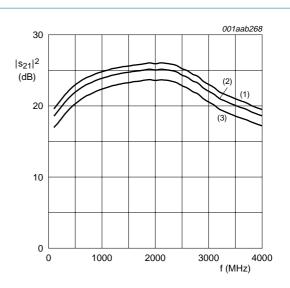




f = 1 GHz;  $Z_0 = 50 Ω$ .

- (1)  $V_S = 5.5 V$ .
- (2)  $V_S = 5 V$ .
- (3)  $V_S = 4.5 V.$

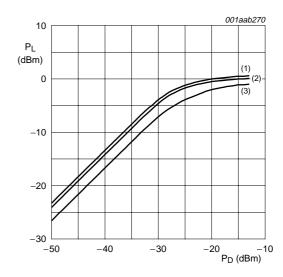
Fig 10. Load power as a function of drive power at 1 GHz; typical values.



 $P_D = -35$  dBm;  $Z_0 = 50$  Ω.

- (1)  $I_S = 8.9 \text{ mA}$ ;  $V_S = 5.5 \text{ V}$ .
- (2)  $I_S = 8 \text{ mA}$ ;  $V_S = 5 \text{ V}$ .
- (3)  $I_S = 7.2 \text{ mA}$ ;  $V_S = 4.5 \text{ V}$ .

Fig 9. Insertion gain ( $|s_{21}|^2$ ) as a function of frequency; typical values.

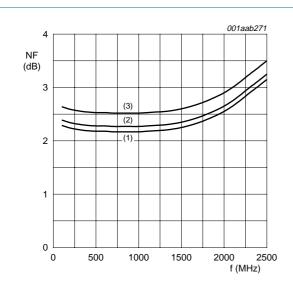


f = 2.2 GHz;  $Z_0 = 50 \Omega$ .

- (1)  $V_S = 5.5 \text{ V}.$
- (2)  $V_S = 5 V$ .
- (3)  $V_S = 4.5 \text{ V}.$

Fig 11. Load power as a function of drive power at 2.2 GHz; typical values.

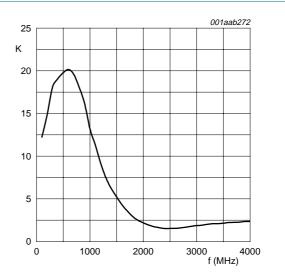
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 $Z_o = 50 \ \Omega$ .

- (1)  $I_S = 8.9 \text{ mA}$ ;  $V_S = 5.5 \text{ V}$ .
- (2)  $I_S = 8 \text{ mA}$ ;  $V_S = 5 \text{ V}$ .
- (3)  $I_S = 7.2 \text{ mA}$ ;  $V_S = 4.5 \text{ V}$ .

Fig 12. Noise figure as a function of frequency; typical values.



 $I_S$  = 8 mA;  $V_S$  = 5 V;  $Z_o$  = 50  $\Omega$ .

Fig 13. Stability factor as a function of frequency; typical values.

Table 8: Scattering parameters

 $V_S=5~V;~I_S=8~mA;~P_D=-35~dBm;~Z_0=50~\Omega;~T_{amb}=25~^{\circ}C.$ 

| f (MHz) | S <sub>11</sub>   |                | s <sub>21</sub>   |                | S <sub>12</sub>   |                | s <sub>22</sub>   |                | K-factor |
|---------|-------------------|----------------|-------------------|----------------|-------------------|----------------|-------------------|----------------|----------|
|         | Magnitude (ratio) | Angle<br>(deg) |          |
| 100     | 0.074378          | 13.78537       | 8.465495          | 22.90763       | 0.003859          | -66.39435      | 0.450496          | 79.88713       | 12.2     |
| 200     | 0.076338          | 13.70153       | 9.420359          | 7.358555       | 0.003112          | -122.2687      | 0.354179          | 40.70919       | 14.9     |
| 400     | 0.123748          | -1.402521      | 11.56481          | -14.92222      | 0.002011          | -40.5142       | 0.312568          | -0.3804        | 19.1     |
| 600     | 0.145511          | -31.32646      | 13.31271          | -37.77988      | 0.001659          | -156.393       | 0.3038            | -25.36808      | 20.2     |
| 800     | 0.134956          | -67.10955      | 14.56872          | -61.08808      | 0.00169           | -164.4454      | 0.30873           | -46.7704       | 18.1     |
| 1000    | 0.114063          | -111.2495      | 15.61733          | -84.67015      | 0.002146          | -174.8593      | 0.319208          | -68.71787      | 13.2     |
| 1200    | 0.101959          | -168.8557      | 16.45625          | -107.9167      | 0.002901          | 139.8136       | 0.335623          | -91.58398      | 9.2      |
| 1400    | 0.125656          | 129.9717       | 17.05668          | -131.63        | 0.004053          | 123.527        | 0.353582          | -116.5485      | 6.2      |
| 1600    | 0.16736           | 85.791         | 17.49643          | -155.2301      | 0.005545          | 107.0763       | 0.366893          | -140.7537      | 4.3      |
| 1800    | 0.234721          | 51.43065       | 17.90167          | -179.6656      | 0.007498          | 105.9423       | 0.404064          | -167.9683      | 2.9      |
| 2000    | 0.285944          | 16.46701       | 17.86635          | 155.5993       | 0.009779          | 90.10168       | 0.42512           | 163.3173       | 2.2      |
| 2200    | 0.339673          | -11.74152      | 17.96498          | 130.5601       | 0.011736          | 75.19814       | 0.459194          | 135.039        | 1.7      |
| 2400    | 0.393746          | -47.58817      | 17.32414          | 103.3297       | 0.013927          | 53.10814       | 0.459988          | 103.1106       | 1.5      |
| 2600    | 0.384353          | -81.55786      | 15.87927          | 77.84766       | 0.015937          | 21.70136       | 0.428158          | 75.83004       | 1.5      |
| 2800    | 0.376183          | -112.353       | 14.44081          | 52.77053       | 0.016795          | 4.656224       | 0.393701          | 50.16202       | 1.7      |
| 3000    | 0.358586          | -142.5801      | 12.67831          | 30.51455       | 0.01786           | -19.19006      | 0.3497            | 26.66791       | 1.9      |
| 3200    | 0.345562          | -171.7261      | 11.27597          | 10.04765       | 0.019217          | -32.22469      | 0.30875           | 6.504047       | 2.0      |
| 3400    | 0.33312           | 160.2254       | 10.43483          | -9.842264      | 0.020551          | -49.16136      | 0.279672          | -12.63121      | 2.1      |
| 3600    | 0.331268          | 133.8644       | 9.743293          | -30.36495      | 0.020908          | -59.65434      | 0.248479          | -33.64811      | 2.2      |
| 3800    | 0.337502          | 108.48         | 9.072149          | -50.7401       | 0.022136          | -78.78085      | 0.21362           | -56.42401      | 2.3      |
| 4000    | 0.344645          | 84.75183       | 8.513716          | -71.86536      | 0.022792          | -94.87525      | 0.168643          | -80.24833      | 2.4      |

## 9. Package outline

#### Plastic surface mounted package; 6 leads

**SOT363** 

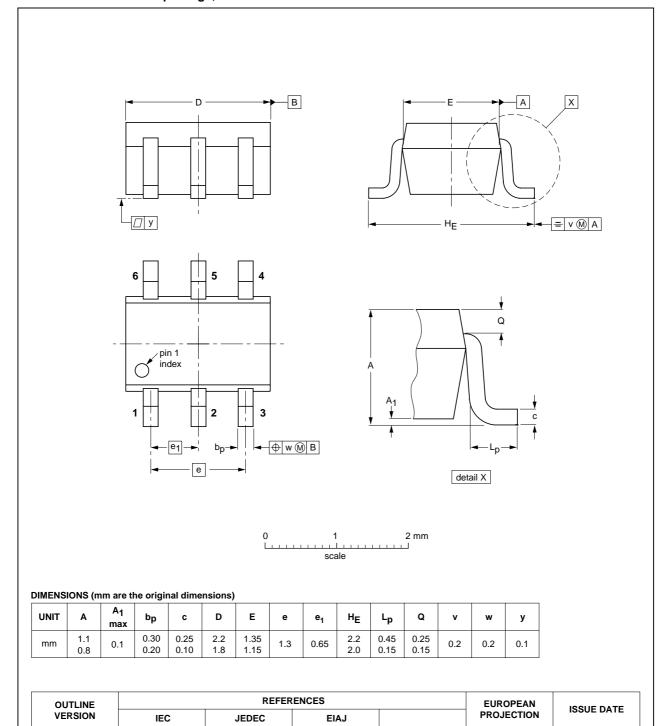


Fig 14. Package outline; SOT363 (SC-88).

97-02-28

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SC-88

SOT363





## 10. Revision history

### Table 9: Revision history

| Document ID    | Release date   | Data sheet status      | Change notice      | Doc. number    | Supersedes  |
|----------------|--|------------------------|--------------------|----------------|-------------|
| BGA2717_2      | 20040924   | Product data sheet     | -                  | 9397 750 13293 | BGA2717_N_1 |
| Modifications: | <ul> <li>The format of this data sheet has been redesigned to comply with the new preser<br/>information standard of Philips Semiconductors</li> </ul> |                        | v presentation and |                |             |
| BGA2717_N_1    | 20040202   | Preliminary data sheet | -                  | 9397 750 12828 | -           |



| Level | Data sheet status [1] | Product status [2] [3] | Definition   |
|-------|-----------------------|------------------------|--|
| I     | Objective data        | Development            | This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.  |
| II    | Preliminary data      | Qualification          | This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.             |
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### **MMIC** wideband amplifier

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